

FIG. 2

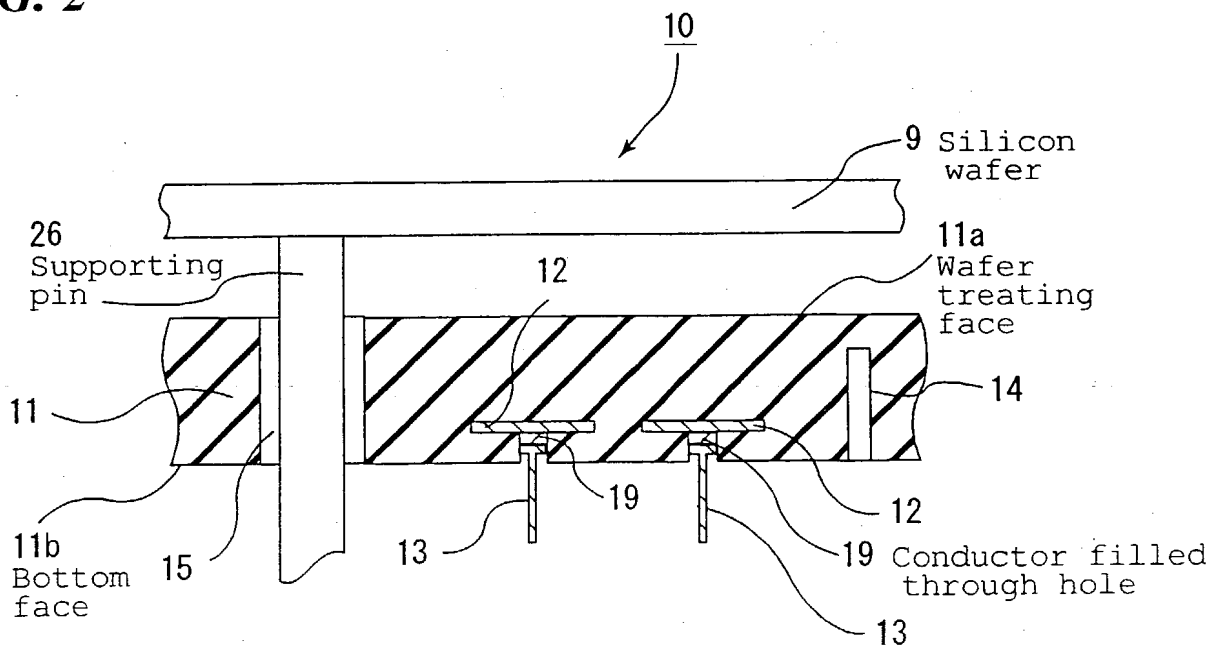


FIG. 3

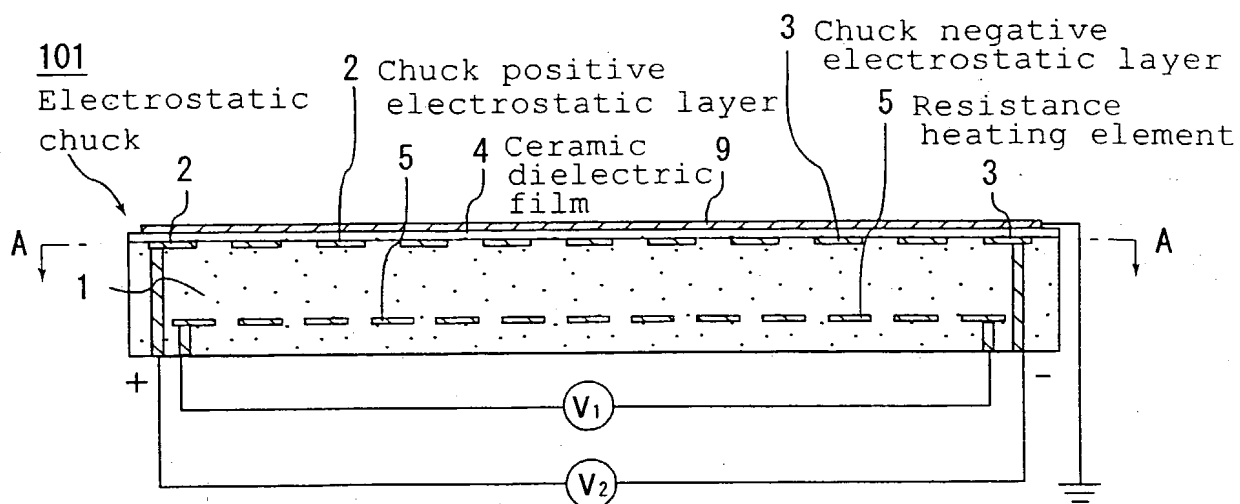


FIG. 4

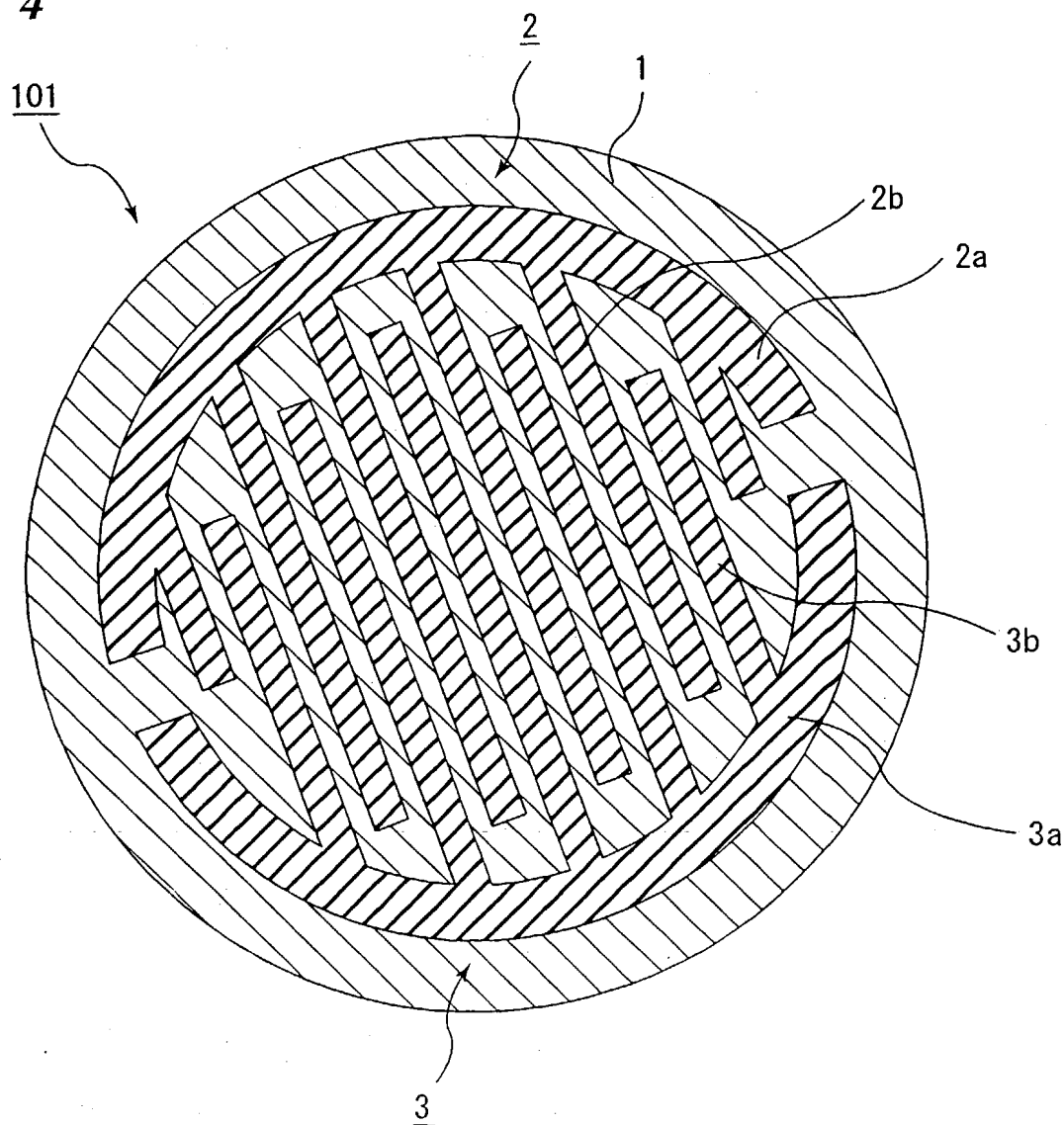


FIG. 5

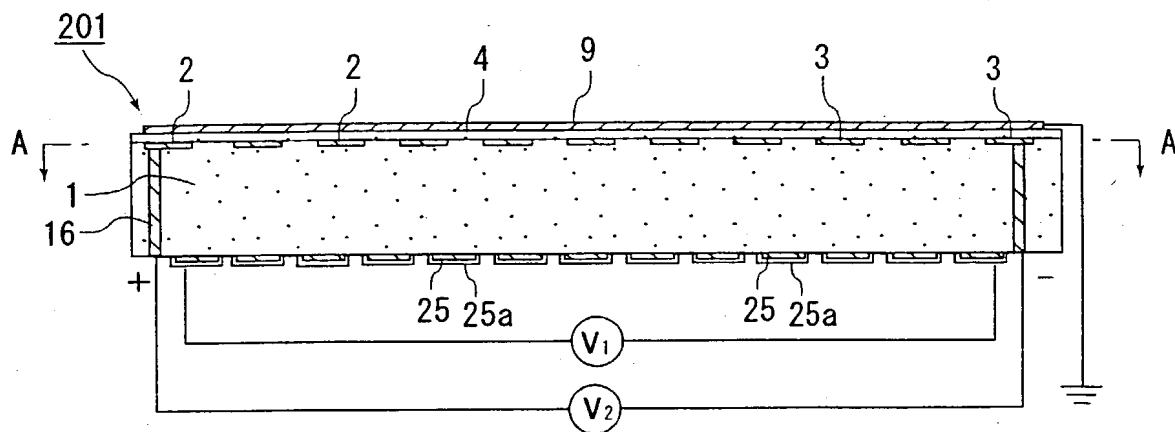


FIG. 6

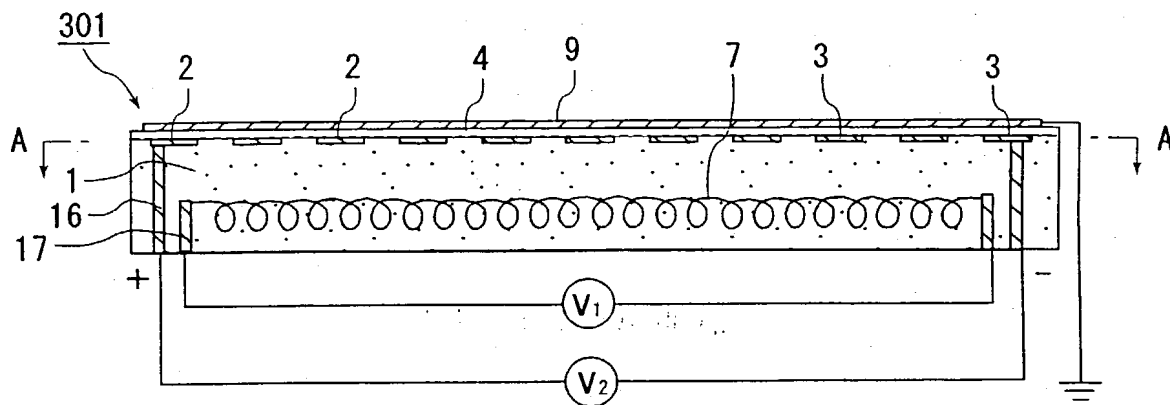


FIG. 7

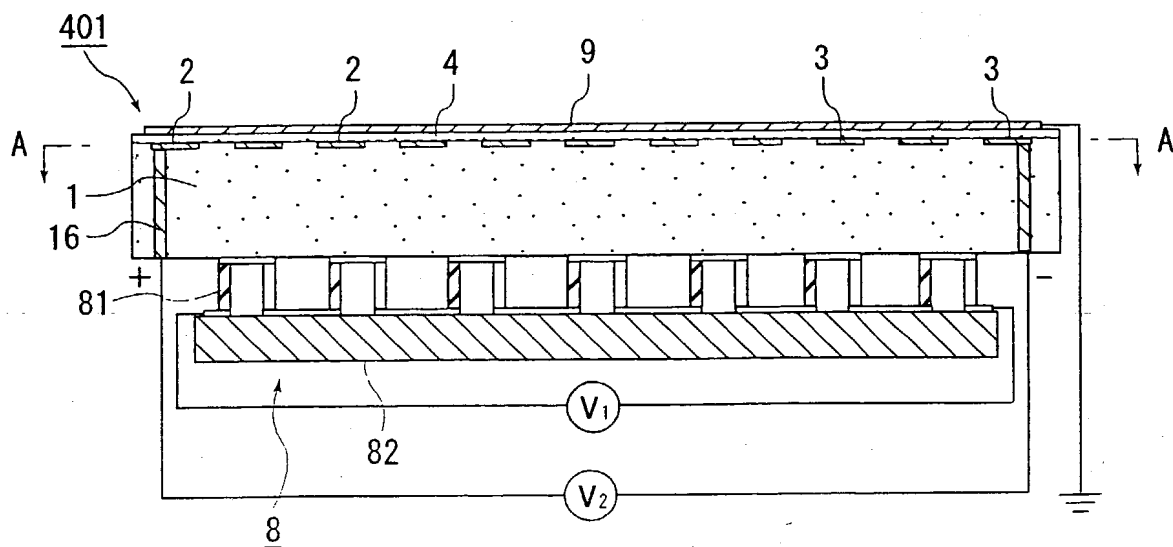
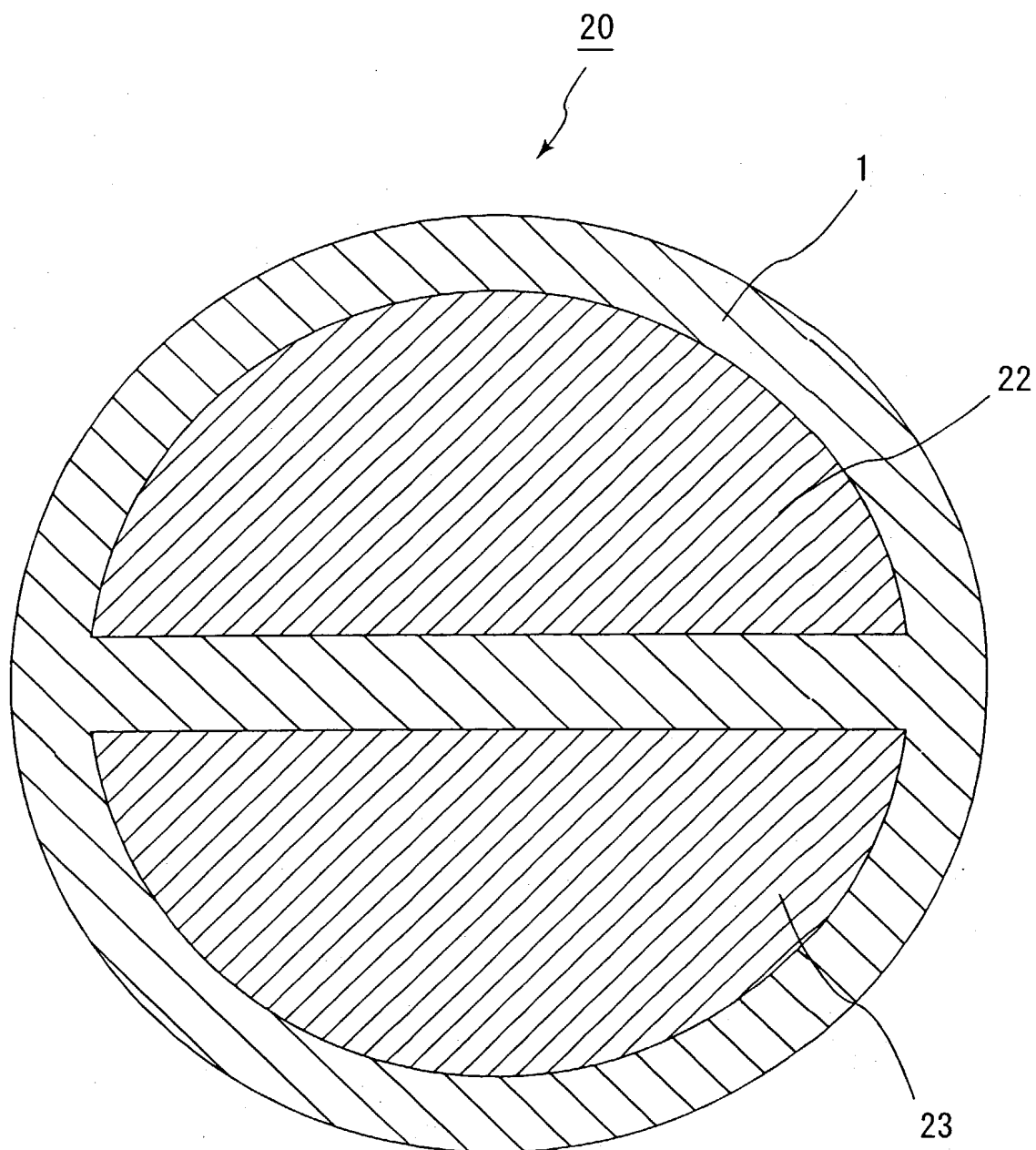
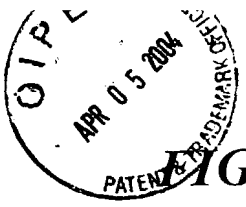


Fig. 8B is a cross-sectional view of a device. It shows a top layer with several components labeled 2, 4, 5, and 3. Component 2 is a thin layer on the left. Component 4 is a series of small rectangular blocks. Component 5 is a thin layer on the right. Component 3 is a series of small rectangular blocks. Below the top layer is a bottom layer with components labeled 1, 16, and 17. Component 1 is a vertical structure on the left. Component 16 is a series of small rectangular blocks. Component 17 is a vertical structure on the right.

FIG. 9





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FIG. 10

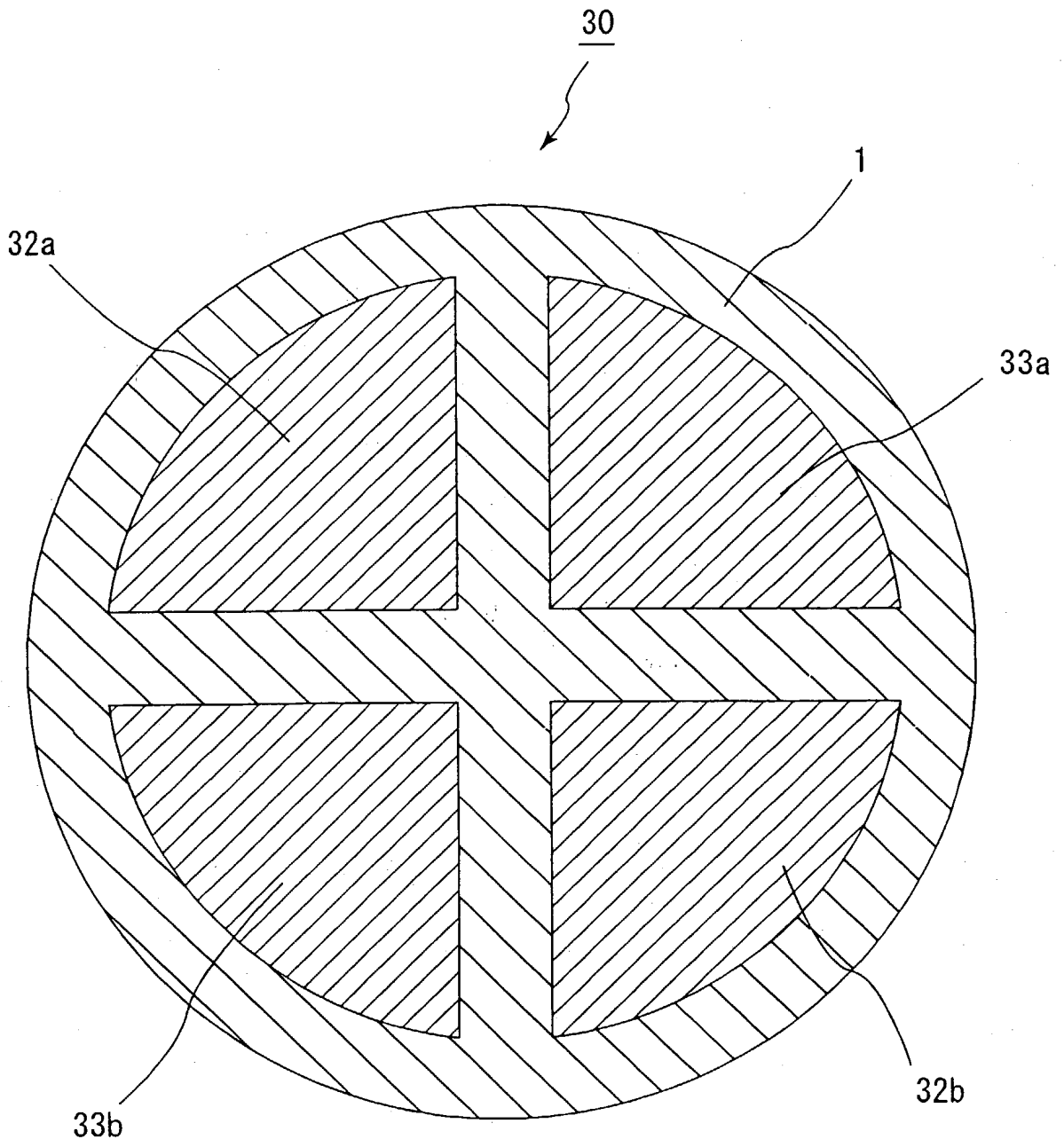


FIG. 11

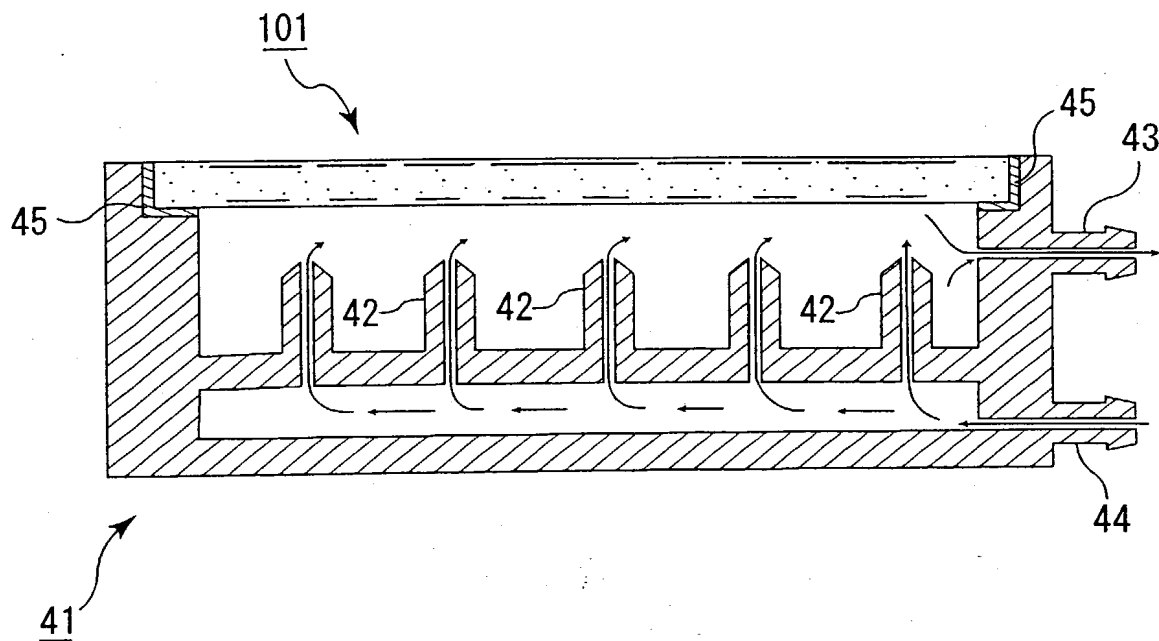


FIG. 12

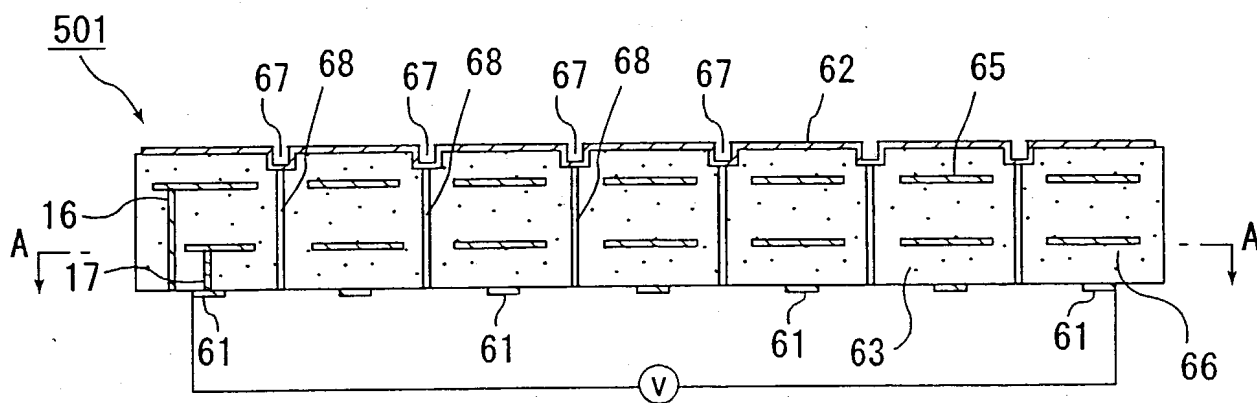


FIG. 13

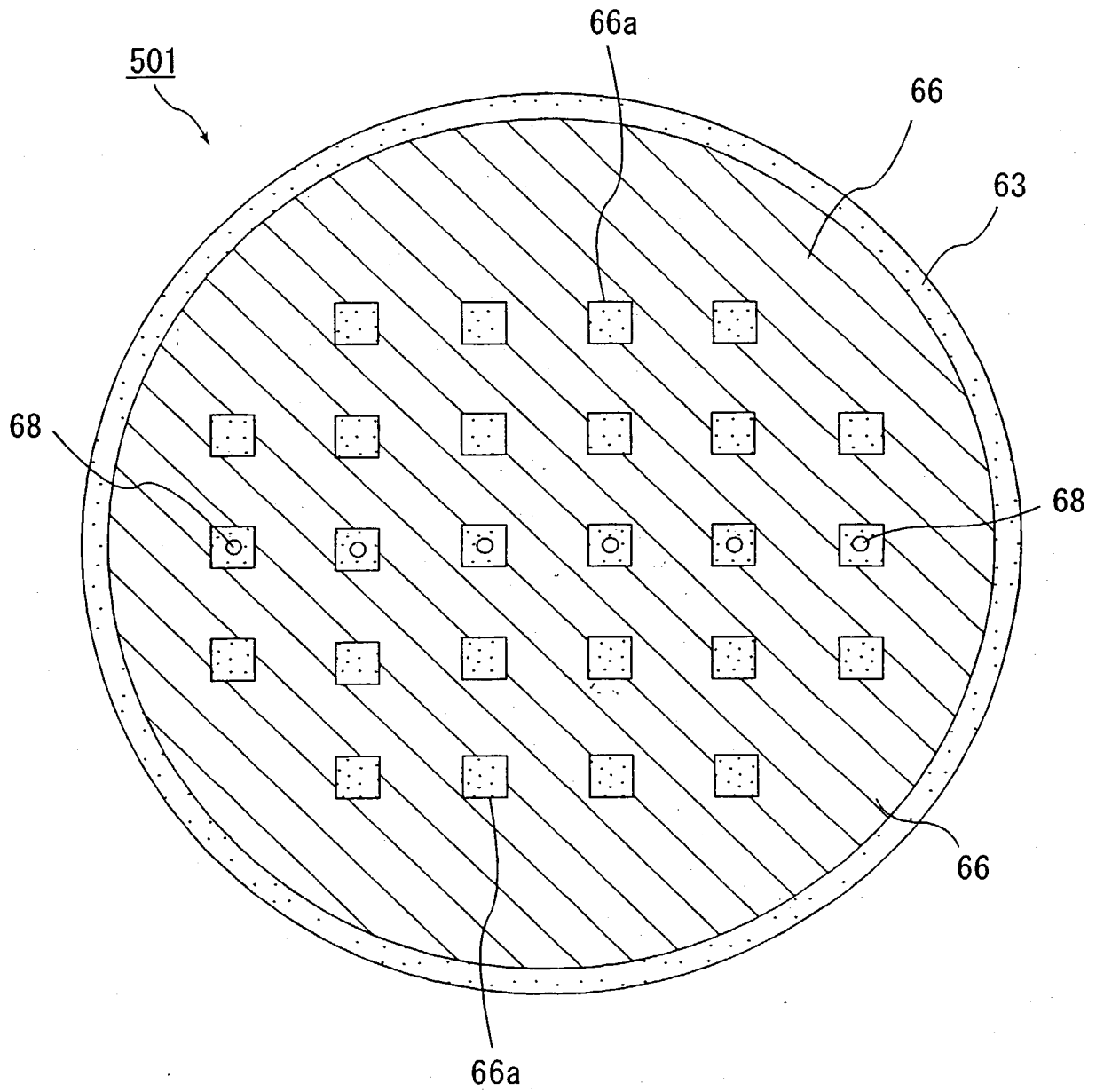


FIG. 14

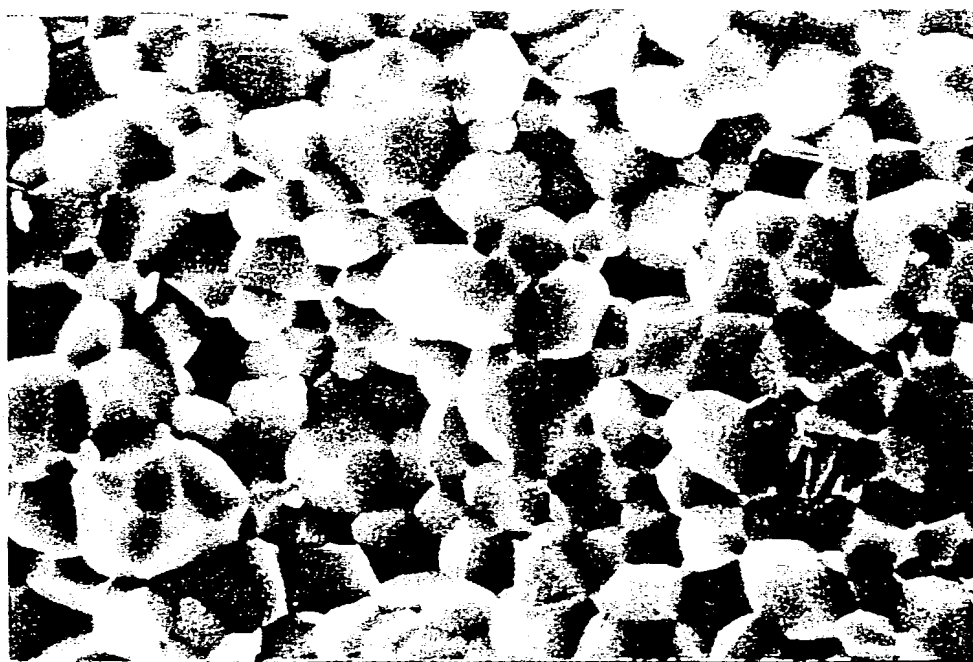


FIG. 15



FIG. 16

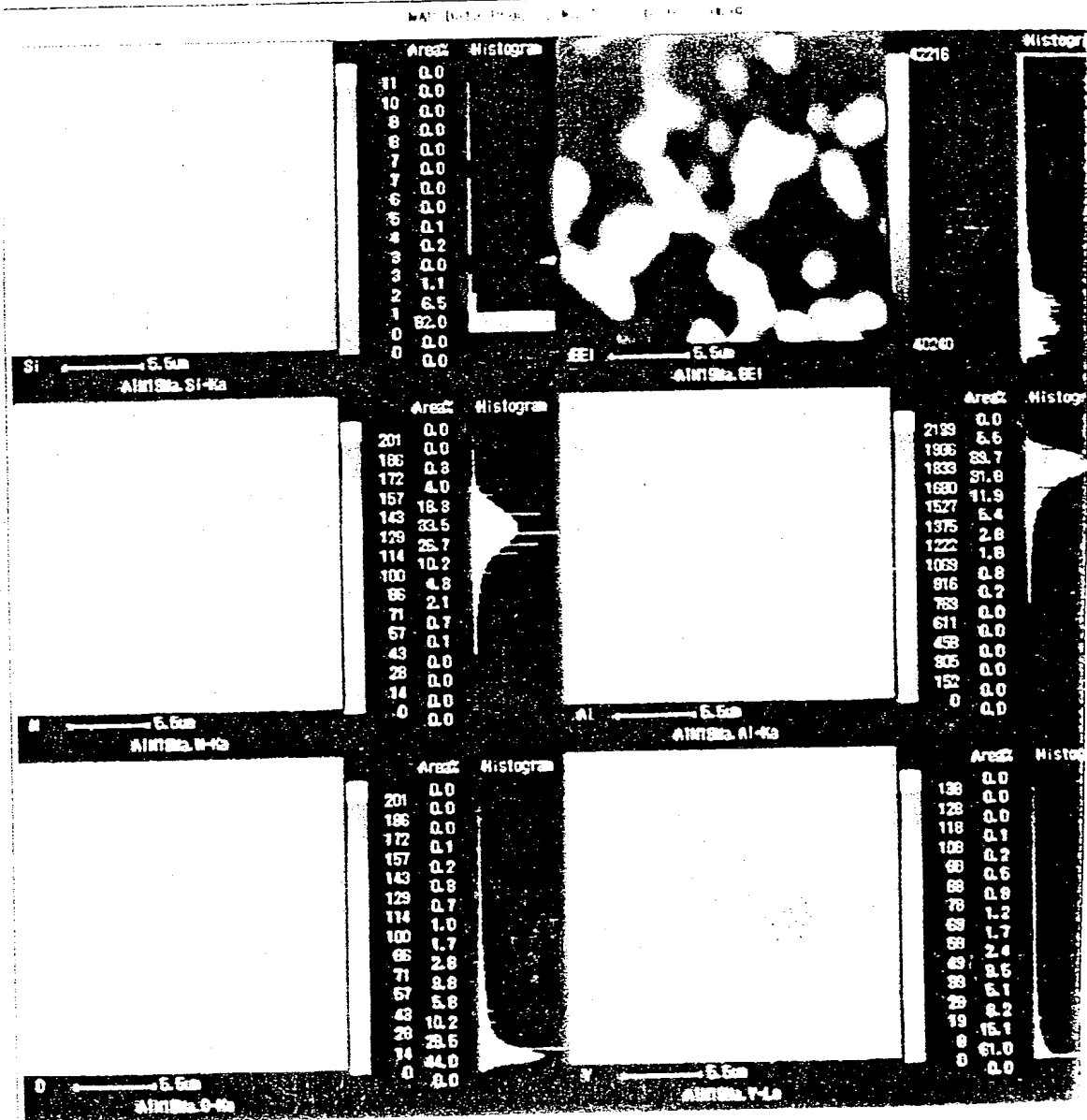


FIG. 17

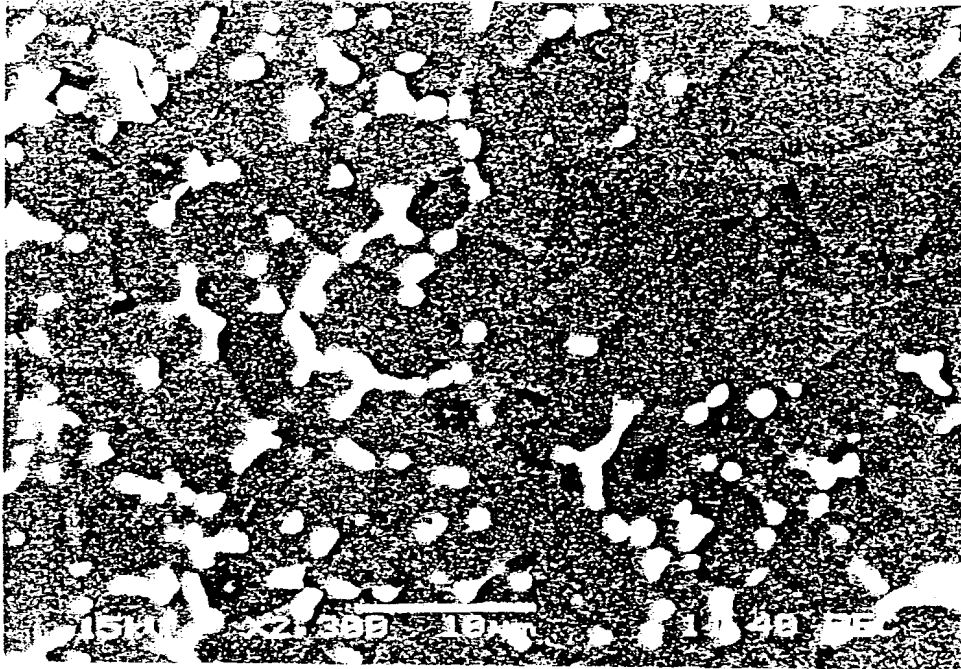


FIG. 18

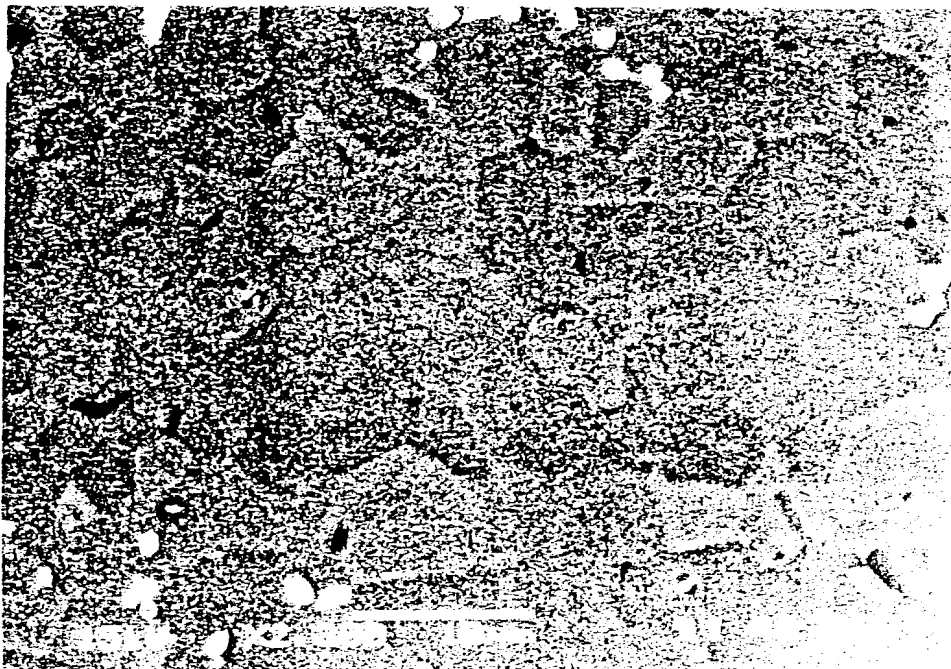


FIG. 19

